

Semiconductor devices — Integrated circuits —

**Part 23-3: Hybrid integrated circuits
and film structures — Manufacturing
line certification — Manufacturers'
self-audit checklist and report**

ICS 31.200

National foreword

This British Standard reproduces verbatim IEC 60748-23-3:2002 and implements it as the UK national standard.

The UK participation in its preparation was entrusted by Technical Committee EPL/47, Semiconductors, to Subcommittee EPL/47/1, Film and hybrid integrated circuits, which has the responsibility to:

- aid enquirers to understand the text;
- present to the responsible international/European committee any enquiries on the interpretation, or proposals for change, and keep the UK interests informed;
- monitor related international and European developments and promulgate them in the UK.

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Amendments issued since publication

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